

OLED PRODUCT SPECIFICATION

Manufactured by:

CD WRITEK GROUP RiTdisplay Corporation

PART NUMBER:	USMP-P18701
DESCRIPTION:	0.7″ OLED, White, 96x16 Resolution, COG, SSD 1307

ISSUE DATE	APPROVED BY	CHECKED BY	PREPARED BY				
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REVISION RECORD

REV.	REVISION DESCRIPTION	REV. DATE	REMARK
X01	INITIAL RELEASE	2007.09.07	
X02	 Add the information of module weight Modify luminance & lifetime specifications Modify D.C electrical characteristics Modify panel electrical specifications Add graphic display data ram address map Add power on/off sequence Add application circuit Modify polarizer dimension 	2007. 10. 31	Page 5, 6, 7, 8, 11, 12, 14, 15 & 17
A01	 Transfer from X version Modify D.C electrical characteristics Modify power on/off sequence Add packing specification 	2008. 04. 08	Page 7, 14 & 18
A02	Modify product name - RGC07096016WR000→ RGS07096016WR000	2008. 05. 27	Page 1

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1. SCOPE

The purpose of this specification is to define the general provisions and quality requirements that apply to the supply of display cells manufactured by RiTdisplay. This document, together with the Module Assembly Drawing, is the highest-level specification for this product. It describes the product, identifies supporting documents and contains specifications, which are either not addressed, or are exceptions to the supporting documents.

2. WARRANTY

RiTdisplay warrants that the products delivered pursuant to this specification (or order) will conform to the agreed specifications for twelve (12) months from the shipping date ("Warranty Period"). RiTdisplay is obligated to repair or replace the products which are found to be defective or inconsistent with the specifications during the Warranty Period without charge, on condition that the products are stored or used as the conditions specified in the specifications. Nevertheless, RiTdisplay is not obligated to repair or replace the products without charge if the defects or inconsistency are caused by the force majeure or the reckless behaviors of the customer.

After the Warranty Period, all repairs or replacements of the products are subject to charge.

3. FEATURES

- Small molecular organic light emitting diode.
- Color : White
- Panel matrix : 96*16
- Driver IC : SSD1307
- Excellent Quick response time : 10µs
- Extremely thin thickness for best mechanism design : 1.41 mm
- High contrast : 2000:1
- Wide viewing angle : 160°
- I²C Interface
- Strong environmental resistance
- Wide range of operating temperature : -40 to 70°C
- Anti-glare polarizer.

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4. MECHANICAL DATA

NO	ITEM	SPECIFICATION	UNIT
1	Dot Matrix	96 (W) x 16 (H)	dot
2	Dot Size	0.164 (W) x 0.185 (H)	mm ²
3	Dot Pitch	0.184 (W) x 0.205 (H)	mm^2
4	Aperture Rate	80	%
5	Active Area	17.644 (W) x 3.26 (H)	mm ²
6	Panel Size	26.3 (W) x 8 (H)	mm ²
7	Panel Thickness	1.41 ± 0.1	mm
8	Module Size	46.3 (W) x 8 (H) x 1.41 (D)	mm ³
9	Diagonal A/A size	0.7	inch
10	Module Weight	0.62 ± 10%	gram

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5. MAXIMUM RATINGS

ITEM	MIN	MAX	UNIT	Condition	Remark
Supply Voltage (V _{DD})	-0.3	+4	V	Ta = 25 °C	IC maximum rating
Supply Voltage (Vcc)	7	16	V	Ta = 25 °C	IC maximum rating
Operating Temp.	-40	70	°C		
Storage Temp	-40	85	°C		
Humidity		85	%		
Life Time	18,000	-	Hrs	160 cd/m ² , 50% checkerboard	Note (1)
Life Time	21,000	-	Hrs	140 cd/m ² , 50% checkerboard	Note (2)
Life Time	25,000	-	Hrs	120 cd/m ² , 50% checkerboard	Note (3)

Note:

(A) Under VCC = 10V, Ta = 25° C, 50% RH.

- (B) Life time is defined the amount of time when the luminance has decayed to less than 50% of the initial measured luminance.
- (1) Setting of 160 cd/m^2 :
 - Contrast setting : 0x41H
 - Frame rate : 105Hz
 - Duty setting : 1/16

(2) Setting of 140 cd/m^2 :

- Contrast setting : 0x39H
- Frame rate : 105Hz
- Duty setting : 1/16

(3) Setting of 120 cd/m^2 :

- Contrast setting : 0x31H
- Frame rate : 105Hz
- Duty setting : 1/16



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6. ELECTRICAL CHARACTERISTICS

6.1 D.C ELECTRICAL CHARACTERISTICS

SYMBOL	PARAMETERS	TEST CONDITION	MIN	TYP	MAX	UNIT
V _{CC}	Analog power supply (for OLED panel)	Ta=-20 °C to +70°C	9.5	10	10.5	V
V_{DD}	Digital power supply	Ta=-20 °C to +70°C	1.65	2.8	3.3	V
I _{DD}	Operating current for V_{DD} VDD = 2.8V, VCC = 12V, IREF = 10uA No Panel attached, All Display ON	Contrast=FF	-	23	30	uA
Icc	Operating current for V_{CC} VDD = 2.8V, VCC = 12V, IREF = 10uA No panel attached, All Display ON	Contrast=FF	-	455	590	uA
VIH	High logic input level		0.8* V _{dd}	-	-	V
VIL	Low logic input level		-	-	0.2* V _{DD}	V
V _{OH}	High logic output level	Ιουτ = 100uA, 3.3MHz	0.9* V _{DD}	-	-	V
V _{OL}	Low logic output level	Ιουτ = 100uA, 3.3MHz	-	-	$0.1^* V_{\text{DD}}$	V
	Segment on output current	Contrast=FF	285	316	345	uA
	V _{DD} =2.8V, V _{CC} =12V,	Contrast=AF	-	217	-	uA
I _{SEG}	IREF=10uA, Display on,	Contrast=7F	-	158	-	uA
		Contrast=3F	-	79	-	uA
		Contrast=0F		19		uA

Note : The Vcc input must keep in a stable value; ripple and noise are not allowed.

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6.2 ELECTRO-OPTICAL CHARACTERISTICS

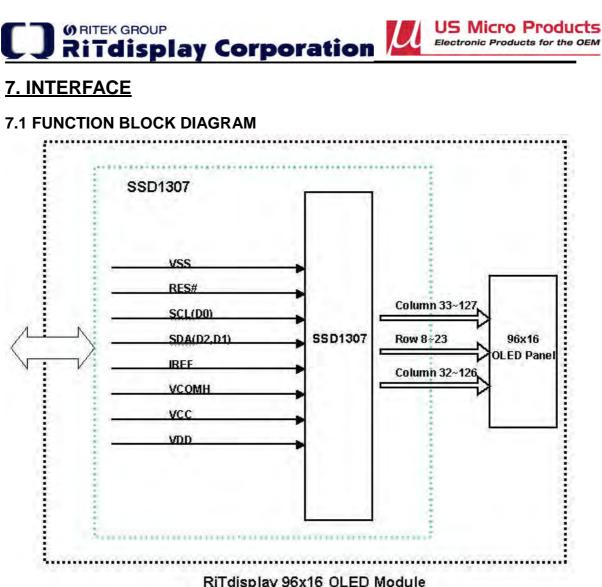
PANEL ELECTRICAL SPECIFICATIONS

PARAMETER	MIN	TYP.	MAX	UNITS	COMMENTS
Normal mode current		3	5	mA	All pixels on (1)
Standby mode current		0.4	0.6	mA	Standby mode 10% pixels on (2)
Normal mode power consumption		30	50	mW	All pixels on (1)
Standby mode power consumption		4	6	mW	Standby mode 10% pixels on (2)
Normal mode Luminance	120	140		cd/m ²	Display Average
Standby mode Luminance		20		cd/m ²	
CIEx (White)	0.24	0.28	0.32		x y (CIE 1021)
CIEy (White)	0.28	0.32	0.36		x, y (CIE 1931)
Dark Room Contrast	2000:1				
Viewing Angle	160			degree	
Response Time		10		μs	

(1) Normal mode condition :

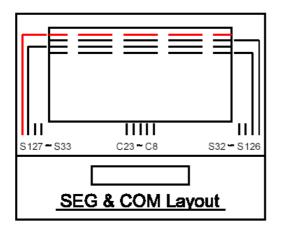
- Driving Voltage : 10V
- Contrast setting : 0x39H
- Frame rate : 105Hz
- Duty setting : 1/16
- (2) Standby mode condition :
 - Driving Voltage : 10V
 - Contrast setting : 0x05H
 - Frame rate : 105Hz
 - Duty setting : 1/16

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RiTdisplay 96x16 OLED Module

7.2 PANEL LAYOUT DIAGRAM



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7.3 PIN ASSIGNMENTS

Pin No.	Pin Name	Description
1	VSS	This is a ground pin.
2	RES#	Hardware reset signal
3	SCL(D0)	I ² C serial clock pin
4	SDA(D2,D1)	I ² C serial data pin
5	IREF	The current reference input pin, this pin should be connected to ground through a resistor.
6	VCOMH	The COM voltage reference pin, this pin should be connected to ground through a capacitor.
7	VCC	Positive OLED high voltage power supply
8	VDD	Power supply for logic circuit

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7.4 GRAPHIC DISPLAY DATA RAM ADDRESS MAP

The GDDRAM is a bit mapped static RAM holding the bit pattern to be displayed. The size of the RAM is 128 x 39 bits and the RAM is divided into five pages, from PAGE0 to PAGE4, which are used for monochrome 128x39 dot matrix display, as shown in below figures.

When one data byte is written into GDDRAM, all the rows image data of the same page of the current column are filled (i.e. the whole column (8 bits) pointed by the column address pointer is filled.). Data bit D0 is written into the top row, while data bit D7 is written into bottom row. For PAGE4, bit D7 is treated as don't care bit.

For mechanical flexibility, re-mapping on both Segment and Common outputs can be selected by software. For vertical shifting of the display, an internal register storing the display start line can be set to control the portion of the RAM data to be mapped to the display (command D3h).

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mapping	nent re- (command	SEG127	SEG126	SEG125	SEG124		SEG4	SEG3	SEG2	SEG1	SEG0	1	
A	\1h)	SE	ß	SE	SE	8 8 8		S	ß	SE			
mapping	nent re- (command RESET])	SEG0	SEG1	SEG2	SEG3	SEG123 SEG124 SEG126 SEG127 SEG127 SEG127							
Page	Data	OLO	001	0012	0013		00L123	00L124	00L125	00L126	00L127	COM Output Scan Direction (command C0h [RESET])	COM Output Scan Direction (command C8h)
	D0											COM0	COM38
	D1		1 18	2 3							1. 10	COM1	COM37
	D2			\$ S				9				COM2	COM36
0	D3		î î	2 - S			î î					COM3	COM35
Ŭ	D4							1 1				COM4	COM34
2	D5		e	7 2							e - 20	COM5	COM33
	D6	_		-			· · · · ·	-			-	COM6	COM32
	D7			\$\$				2			Ĩ	COM7	COM31
	D0											COM8	COM30
	D1					Let a let						COM9	COM29
1	D2				_							COM10	COM28
	D3		1 10	8 3				2			1	COM11	COM27
	D4			×		5.14 500 5256						COM12	COM26
	D5											COM13	COM25
3	D6 D7											COM14 COM15	COM24 COM23
-				7 - 2 7 - 2		<u> </u>		4					
	D0			<u>1</u>								COM16	COM22
2	D1 D2					Each box repre	sen	ts o	nel	bit		COM17	COM21 COM20
	D2 D3			-		of image data	_				-	COM18 COM19	COM20 COM19
2	D3 D4						2 - 2	3			· · · ·	COM19 COM20	COM19 COM18
1	D4 D5			8 - 3	_	200-0000, 200 A	<u> </u>	9 9		_	r - 7	COM20 COM21	COM18 COM17
	D5 D6			2 5	_				_	_		COM21 COM22	COM16
1	D0 D7	-	_							_	_	COM22 COM23	COM15
	D7 D0		_		_			_			_	COM23	COM14
1	D0 D1		-				-		_		-	COM25	COM14 COM13
9	D1 D2		c - 22	15 - 21			<u> </u>	8 - 8		_	n - 19	COM25 COM26	COM13 COM12
	D2 D3			2 - 5							a - 9	COM26	COM12 COM11
3	D3 D4			× - 2	-		-					COM28	COM10
	D4 D5										-	COM29	COM10 COM9
8	D5 D6			-								COM29 COM30	COM8
	D0 D7			15 31 								COM30	COM8 COM7
	D0							2 9			6 (9) C (9)	COM32	COM6
	D0 D1										6 P.	COM32	COM5
5	D2					1						COM34	COM4
4	D2 D3											COM35	COM3
	D0											COM36	COM2
8	D5		- DA	a 2		1		-0 - V			s - 94	COM37	COM1
2	D6					1			-			COM38	COM0
	D7			_		Don't care bit							

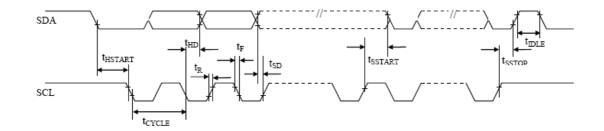
GDDRAM pages structure of SSD1307

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7.5 INTERFACE TIMING CHART

I2C Interface Timing Characteristics

Symbol	Parameter	Min	Тур	Max	Unit
t _{cycle}	Clock Cycle Time	2.5	-	-	us
t _{HSTART}	Start condition Hold Time	0.6	-	-	us
t _{HD}	Data Hold Time (for "SDA _{OUT} " pin)	0	-	-	ns
	Data Hold Time (for "SDA _{IN} " pin)	300	-	-	ns
t _{SD}	Data Setup Time	100	-	-	ns
t _{SSTART}	Start condition Setup Time (Only relevant for a repeated Start condition)	0.6	-	-	us
tSSTOP	Stop condition Setup Time	0.6	-	-	us
t _R	Rise Time for data and clock pin	-	-	300	ns
t _F	Fall Time for data and clock pin	-	-	300	ns
t _{IDLE}	Idle Time before a new transmission can start	1.3	-	-	us



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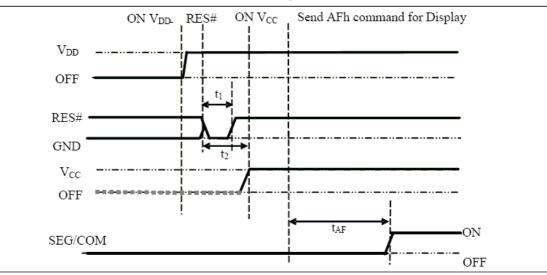
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8. POWER ON / OFF SEQUENCE & APPLICATION CIRCUIT

8.1 POWER ON / OFF SEQUENCE

Power ON sequence:

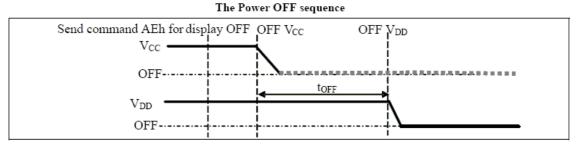
- 1. Power ON VDD
- 2. After VDD become stable, set RES# pin LOW (logic low) for at least 3us (t₁) ⁽³⁾ and then HIGH (logic high).
- 3. After set RES# pin LOW (logic low), wait for at least 3us (t₂). Then Power ON Vcc. ⁽¹⁾
- 4. After Vcc become stable, send command AFh for display ON. SEG/COM will be ON after 100ms (tAF).



The Power ON sequence

Power OFF sequence:

- 1. Send command AEh for display OFF.
- 2. Power OFF Vcc (1), (2)
- 3. Power OFF V_{DD} after t_{OFF} .⁽⁴⁾ (where Minimum t_{OFF} =80ms, Typical t_{OFF} =100ms)



Note:

 $^{(1)}V_{CC}$ should be disabled when it is OFF.

⁽²⁾ Power Pins (V_{DD} , V_{CC}) can never be pulled to ground under any circumstance.

⁽³⁾ The register values are reset after t₁.

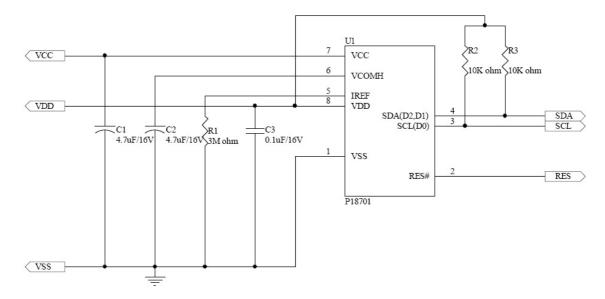
 $^{(4)}$ V_{DD} should not be Power OFF before V_{CC} Power OFF.

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8.2 APPLICATION CIRCUIT



Component:

C1, C2: 4.7uF/16V(0805) C3: 0.1uF/16V(0603) R1: 3M ohm 1% (0603) R2, R3: 10K ohm(0603) This circuit is for I²C interface.

8.3 COMMAND TABLE

Refer to SSD1307 IC Spec.

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9. RELIABILITY TEST CONDITIONS

No.	Items	Specification	Quantity
1	High temp. (Non-operation)	85°C, 240hrs	5
2	High temp. (Operation)	70°C, 120hrs	5
3	Low temp. (Operation)	-40°C, 120hrs	5
4	High temp. / High humidity (Operation)	65°C, 90%RH, 120hrs	5
5	Thermal shock (Non-operation)	-40°C ~85°C (-40°C /30min; transit /3min; 85°C /30min; transit /3min) 1cycle: 66min, 100 cycles	5
6	Vibration	Frequency : 5~50HZ, 0.5G Scan rate : 1 oct/min Time : 2 hrs/axis Test axis : X, Y, Z	1 Carton
7	Drop	Height: 120cm Sequence : 1 angle \ 3 edges and 6 faces Cycles: 1	1 Carton
8	ESD (Non-operation)	Air discharge model, ±8kV, 10 times	5

Test and measurement conditions

- 1. All measurements shall not be started until the specimens attain to temperature stability.
- 2. All-pixels-on is used as operation test pattern.
- 3. The degradation of Polarizer are ignored for item 1, 4 & 5.

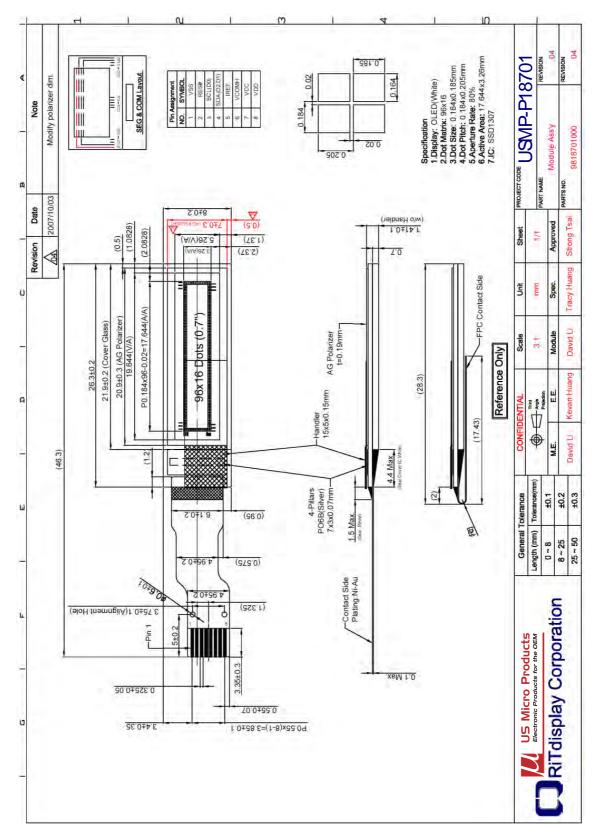
Evaluation criteria

- 1. The function test is OK.
- 2. No observable defects.
- 3. Luminance: > 50% of initial value.
- 4. Current consumption: within \pm 50% of initial value.

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10. EXTERNAL DIMENSION

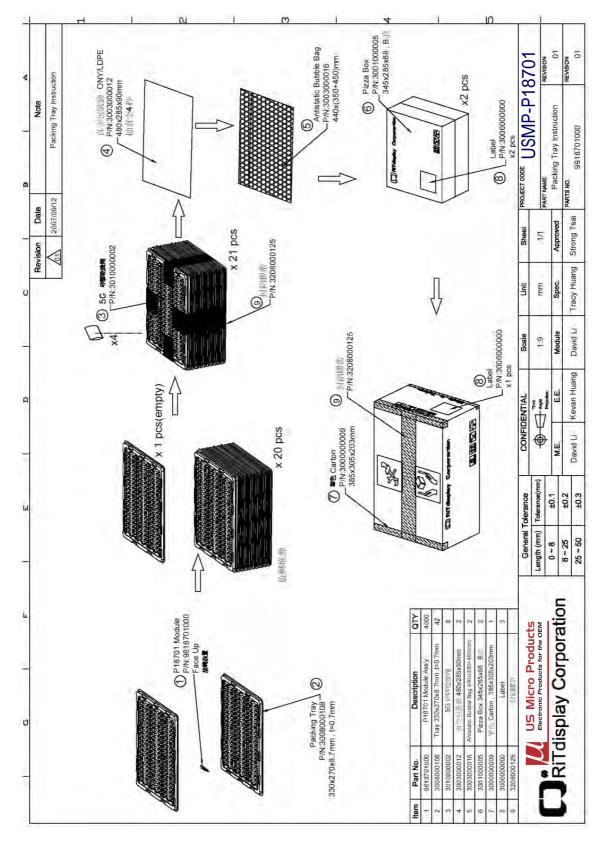


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11. PACKING SPECIFICATION



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12. APPENDIXES

APPENDIX 1: DEFINITIONS

A. DEFINITION OF CHROMATICITY COORDINATE

The chromaticity coordinate is defined as the coordinate value on the CIE 1931 color chart for R, G, B, W.

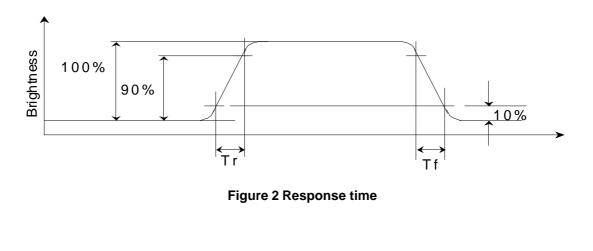
B. DEFINITION OF CONTRAST RATIO

The contrast ratio is defined as the following formula:

Contrast Ratio = Luminance of all pixels on measurement Luminance of all pixels off measurement

C. DEFINITION OF RESPONSE TIME

The definition of turn-on response time Tr is the time interval between a pixel reaching 10% of steady state luminance and 90% of steady state luminance. The definition of turn-off response time Tf is the time interval between a pixel reaching 90% of steady state luminance and 10% of steady state luminance. It is shown in Figure 2.



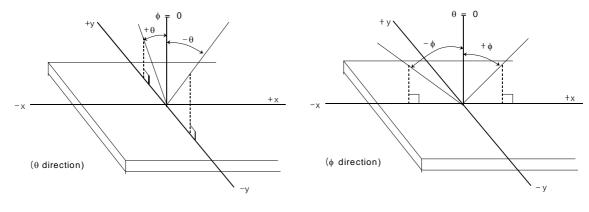
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D. DEFINITION OF VIEWING ANGLE

The viewing angle is defined as Figure 3. Horizontal and vertical (H & V) angles are determined for viewing directions where luminance varies by 50% of the perpendicular value.



Vertical angles

Horizontal angles

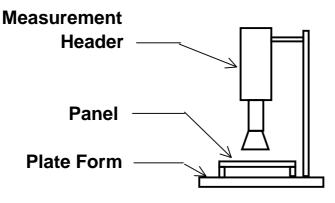
Figure 3 Viewing Angle

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APPENDIX 2: MEASUREMENT APPARATUS

A. LUMINANCE/COLOR COORDINATE

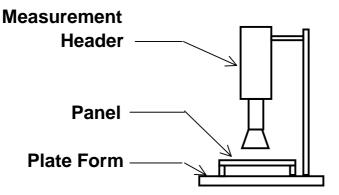
PHOTO RESEARCH PR-705, MINOLTA CS-100



PR-705 / MINOLTA CS-100 Color Analyzer

B. CONTRAST / RESPONSE TIME / VIEWING ANGLE

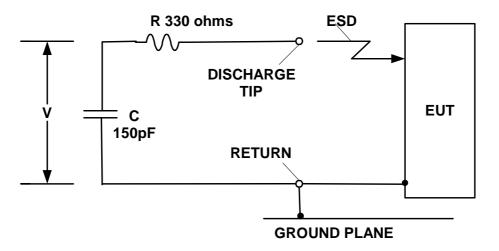
WESTAR CORPORATION FPM-510



Westar FPM-510 Display Contrast / Response time / View angle Analyzer



C. ESD ON AIR DISCHARGE MODE



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APPENDIX 3: PRECAUTIONS

A. RESIDUE IMAGE

Because the pixels are lighted in different time, the luminance of active pixels may reduce or differ from inactive pixels. Therefore, the residue image will occur. To avoid the residue image, every pixel needs to be lighted up uniformly.

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